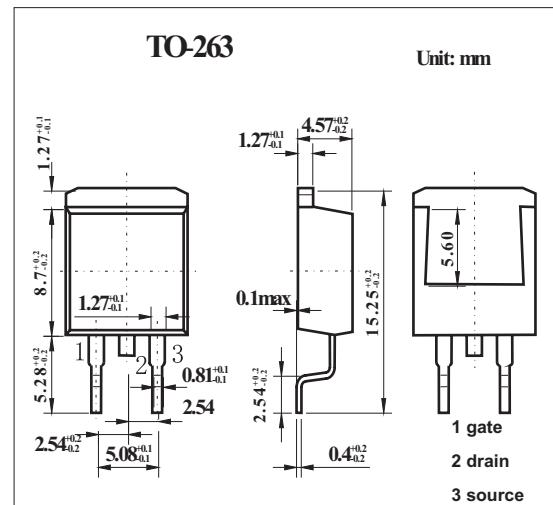


TrenchPLUS standard level FET

KUK7105-40AIE



■ Features

- Integrated temperature sensor
- Electrostatic discharge protection
- Q101 compliant
- Standard level compatible.

■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain-source voltage	V _{DS}	40	V
Drain-gate voltage R _{GS} = 20 KΩ	V _{DGS}	40	V
Gate-source voltage	V _{GS}	±20	V
Drain current (DC) T _{mb} = 25°C, V _{GS} = 10 V	I _D	155	A
Drain current (DC) T _{mb} = 100°C, V _{GS} = 10 V	I _D	75	A
peak drain current *1	I _{DM}	620	A
Total power dissipation T _{mb} = 25°C	P _{tot}	272	W
gate-source clamping current (continuous)	I _{GS(CL)}	10	mA
gate-source clamping current *3		50	mA
Storage & operating temperature	T _{stg} , T _j	-55 to 175	°C
reverse drain current (DC) T _{mb} = 25°C	I _{DR}	155	A
		75	A
pulsed reverse drain current *1	I _{DRM}	620	A
non-repetitive avalanche energy *2	E _{DS(AL)} S	1.46	J
Thermal resistance junction to mounting base	R _{th j-mb}	0.55	K/W
Thermal resistance junction to ambient	R _{th j-a}	50	K/W

* 1 T_{mb} = 25°C; pulsed; tp ≤ 10 μs;

*2 unclamped inductive load; I_D = 75 A; V_{DS} ≤ 40 V; V_{GS} = 10 V; R_{GS} = 50Ω; starting T_j = 25°C

*3 tp = 5 ms; δ = 0.01

KUK7105-40AIE

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
drain-source breakdown voltage	V(BR)DSS	Id = 0.25 mA; Vgs = 0 V; Tj = 25°C	40			V
		Id = 0.25 mA; Vgs = 0 V; Tj = -55°C	36			V
gate-source threshold voltage	Vgs(th)	Id = 1 mA; Vds = Vgs; Tj = 25°C	2	3	4	V
		Id = 1 mA; Vds = Vgs; Tj = 175°C	1			V
		Id = 1 mA; Vds = Vgs; Tj = -55°C			4.4	V
Zero gate voltage drain current	IdSS	Vds = 40 V; Vgs = 0 V; Tj = 25°C		0.1	10	µ A
		Vds = 40 V; Vgs = 0 V; Tj = 175°C			250	µ A
gate-source breakdown voltage	V(BR)GSS	Ig = ±1 mA; -55 °C < Tj < 175°C	20	22		V
gate-source leakage current	Igss	Vgs = ±10 V; Vds = 0 V; Tj = 25°C		22	1000	nA
		Vgs = ±10 V; Vds = 0 V; Tj = 175°C			10	µ A
drain-source on-state resistance	RDSon	Vgs = 10 V; Id = 50 A; Tj = 25°C	.	4.5	5	mΩ
		Vgs = 10 V; Id = 50 A; Tj = 175°C			9.5	mΩ
drain-Isense on-state resistance	RD(Is)on	Vgs = 10 V; Id = 100 mA; Tj = 25°C	0.98	1.08	1.18	Ω
		Vgs = 10 V; Id = 100 mA; Tj = 175°C	1.86	2.05	2.24	Ω
ratio of drain current to sense current	Id/Isense	Vgs > 10 V; -55 °C < Tj < 175°C	450	500	550	
total gate charge	Qg(tot)	Vgs = 10 V; Vdd = 32 V; Id = 25 A		120	127	nC
gate-to-source charge	Qgs			19	22	nC
gate-to-drain (Miller) charge	Qgd			50	60	nC
input capacitance	Ciss	Vgs = 0 V; Vds = 25 V; f = 1 MHz		4300	5000	pF
output capacitance	Coss			1400	1670	pF
reverse transfer capacitance	Crss			820	1100	pF
turn-on delay time	td(on)	Vdd = 30 V; RL = 1.2Ω; Vgs = 10 V; Rg = 10Ω		35		ns
rise time	tr			115		ns
turn-off delay time	td(off)			155		ns
fall time	tf			110		ns
internal drain inductance	Ld	measured from upper edge of drain mounting base to center of die		2.5		nH
internal source inductance	Ls	measured from source lead to source bond pad		7.5		nH
source-drain (diode forward) voltage	Vsd	Is = 25A; Vgs = 0 V		0.85	1.2	V
reverse recovery time	trr	Is = 20 A; dIf/dt = -100 A/µs; Vgs = -10 V; Vds = 30 V		96		ns
recovered charge	Qr			224		nC